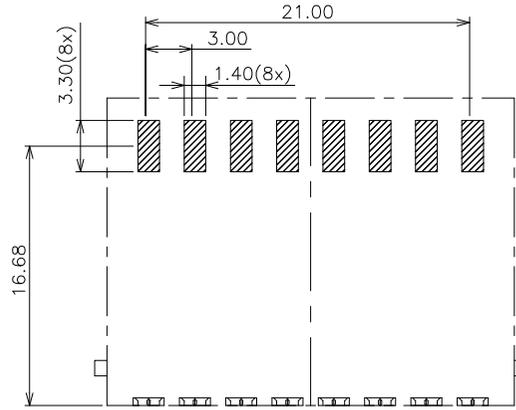
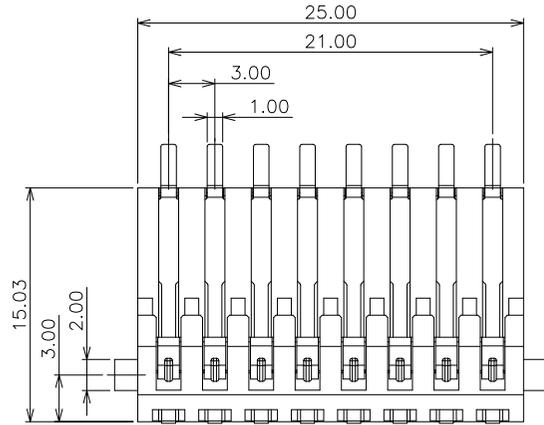


GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2015/12/28	Phebe Su
A1			Change	2022/04/23	Hanson
A2			Change DIM.	2022/05/12	Hanson

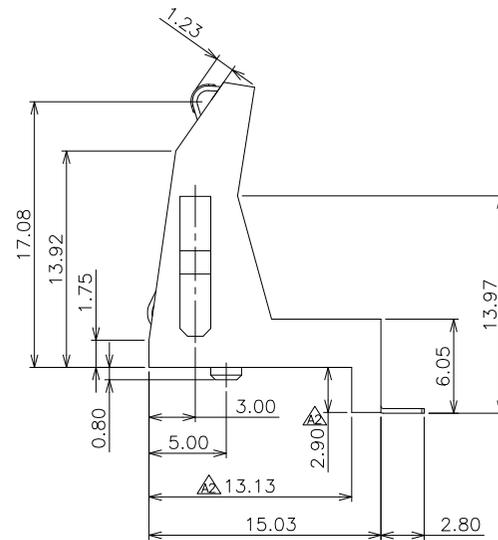
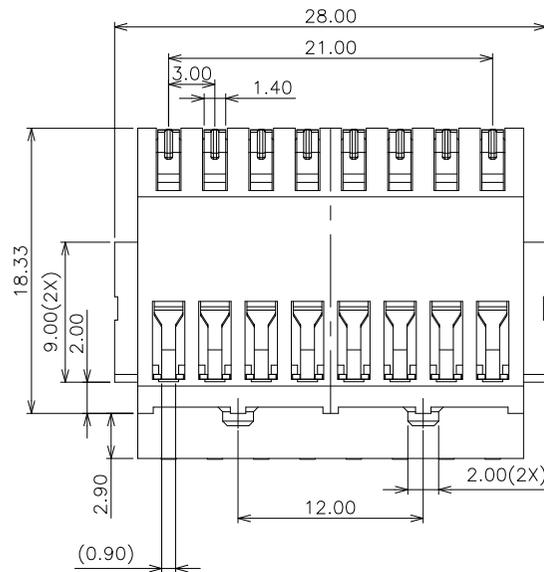
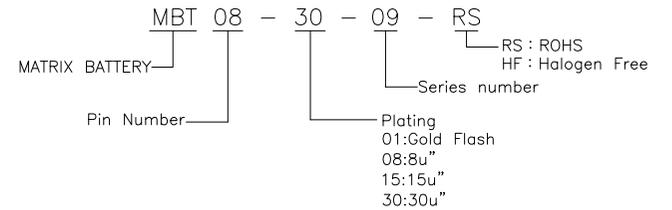


PCB LAYOUT

NOTES.

1. ELECTRICAL
 - 1.1 CURRENT RATING:3.0A PER PIN MAX.
 - 1.2 CONTACT RESISTANCE: 35m OHM MIN.
 - 1.3 INSULATION RESISTANCE: 1000M OHM MIN.
 - 1.4 DIELECTRIC WITHSTANDING VOLTAGE:20V.AC.
2. MATERIALS
 - 2.1 HOUSING: HIGH TEMPERATURE POLYESTER,UL 94V-0. BLACK
 - 2.2 TERMINAL: COPPER ALLOY .
3. UNLESS OTHERWISE SPECIFIED TOLERANCE:AS SHOW AS GENERAL TOLERANCE
4. LIFE TEST:150000CYCLES.
5. OPERATION TEMPERATURE:-40C°~+85C°
6. PRODUCT COMPLIANT TO ROHS AND HALOGEN FREE.

MATRIX PART NO:



Matrix Electronics Co., Ltd

TOLERANCE: X.X ±0.30 X.XX ±0.20 X.XXX ±0.10 ANGLE: ±3°	DESIGN BY :	DATE :	PART NAME:	
	Hanson Huang	2022/05/12	BATTERY R/A SMT TYPE	
UNIT: mm [inch] SCALE:1:1 SIZE:A4	CHECKED BY:	DATE :	PART NO.	MBT08-30-09-RS
	Vicky Hsieh	2022/05/12		
	APPROVED BY1:	DATE :	MOLD NO.	NA
	Richard Hsieh	2022/05/12		
		APPROVED BY2:	DATE :	DRAW NO.
		Richard Hsieh	2022/05/12	SHEET NO. 1 OF 1